**Preferred Device** 

# Self-Protected FET with Temperature and Current Limit

# 42 V, 20 A, Single N-Channel, DPAK

HDPlus<sup>™</sup> devices are an advanced series of power MOSFETs which utilize ON Semiconductors latest MOSFET technology process to achieve the lowest possible on-resistance per silicon area while incorporating smart features. Integrated thermal and current limits work together to provide short circuit protection. The devices feature an integrated Drain-to-Gate Clamp that enables them to withstand high energy in the avalanche mode. The Clamp also provides additional safety margin against unexpected voltage transients. Electrostatic Discharge (ESD) protection is provided by an integrated Gate-to-Source Clamp.

#### **Features**

- Short Circuit Protection/Current Limit
- Thermal Shutdown with Automatic Restart
- I<sub>DSS</sub> Specified at Elevated Temperature
- Avalanche Energy Specified
- Slew Rate Control for Low Noise Switching
- Overvoltage Clamped Protection

#### MOSFET MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage Internally Clamped	$V_{DSS}$	42	Vdc
Gate-to-Source Voltage	$V_{GS}$	±14	Vdc
Drain Current Continuous	I <sub>D</sub>	Internally L	imited
Total Power Dissipation @ T <sub>A</sub> = 25°C (Note 1) @ T <sub>A</sub> = 25°C (Note 2)	P <sub>D</sub>	1.3 2.3	W
Thermal Resistance Junction-to-Case Junction-to-Ambient (Note 1) Junction-to-Ambient (Note 2)	$egin{array}{l} R_{ hetaJC} \ R_{ hetaJA} \ R_{ hetaJA} \end{array}$	3.0 95 54	°C/W
Single Pulse Drain-to-Source Avalanche Energy $(V_{DD}=25~\text{Vdc},~V_{GS}=5.0~\text{Vdc},\\ I_L=2.6~\text{Apk},~L=120~\text{mH},~R_G=25~\Omega)$	E <sub>AS</sub>	400	mJ
Operating and Storage Temperature Range (Note 3)	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

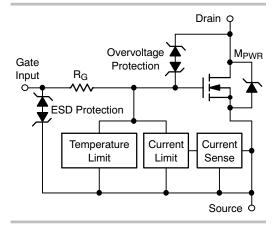
- 1. Surface mounted onto minimum pad size (0.412" square) FR4 PCB, 1 oz cu.
- 2. Mounted onto 1" square pad size (1.127" square) FR4 PCB, 1 oz cu.
- 3. Normal pre-fault operating range. See thermal limit range conditions.

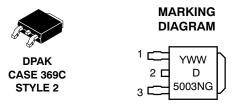


#### ON Semiconductor®

#### http://onsemi.com

V <sub>DSS</sub> (Clamped)	R <sub>DS(on)</sub> TYP	I <sub>D</sub> MAX (Limited)
42 V	42 mΩ @ 10 V	20 A*





 D5003N = Device Code
 1 = Gate

 Y = Year
 2 = Drain

 WW = Work Week
 3 = Source

 G = Pb-Free Device

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NID5003NT4	DPAK	2500/Tape & Reel
NID5003NT4G	DPAK (Pb-Free)	2500/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.

\*Max current may be limited below this value depending on input conditions.

## $\textbf{MOSFET ELECTRICAL CHARACTERISTICS} \ (T_J = 25^{\circ}\text{C unless otherwise noted})$

С	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Drain-to-Source Clamped Br $(V_{GS} = 0 \text{ Vdc}, I_D = 250 \mu\text{Ad})$ $(V_{GS} = 0 \text{ Vdc}, I_D = 250 \mu\text{Ad})$	V <sub>(BR)DSS</sub>	42 40	46 45	51 51	Vdc	
Zero Gate Voltage Drain Current (V <sub>DS</sub> = 32 Vdc, V <sub>GS</sub> = 0 Vdc) (V <sub>DS</sub> = 32 Vdc, V <sub>GS</sub> = 0 Vdc, T <sub>J</sub> = 150°C)			- -	0.6 2.5	5.0	μAdc
Gate Input Current (V <sub>GS</sub> = 5.0 Vdc, V <sub>DS</sub> = 0 Vd	lc)	I <sub>GSSF</sub>	-	50	125	μAdc
ON CHARACTERISTICS		<del>'</del>		<del>!</del>		
Gate Threshold Voltage (V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 1.2 mAdc) Threshold Temperature Co		V <sub>GS(th)</sub>	1.0	1.7 5.0	2.2	Vdc -mV/°C
Static Drain-to-Source On-Fi $(V_{GS} = 10 \text{ Vdc}, I_D = 3.0 \text{ Add})$ $(V_{GS} = 10 \text{ Vdc}, I_D = 3.0 \text{ Add})$	R <sub>DS(on)</sub>	- -	42 76	51 104	mΩ	
Static Drain-to-Source On-Fi $(V_{GS} = 5.0 \text{ Vdc}, I_D = 3.0 \text{ Ad})$ $(V_{GS} = 5.0 \text{ Vdc}, I_D = 3.0 \text{ Ad})$	R <sub>DS(on)</sub>	- -	50 88	58 125	mΩ	
Source-Drain Forward On Vo	V <sub>SD</sub>	-	0.95	1.1	V	
SWITCHING CHARACTERIST	rics			•	•	•
Turn-on Time (V <sub>in</sub> to 90% I <sub>D</sub> )	$R_L = 4.7 \ \Omega, V_{in} = 0 \text{ to } 10 \ V, V_{DD} = 12 \ V$	T <sub>(on)</sub>	-	16	20	μs
Turn-off Time (V <sub>in</sub> to 10% I <sub>D</sub> )	$R_L = 4.7 \ \Omega, V_{in} = 0 \text{ to } 10 \ V, V_{DD} = 12 \ V$	T <sub>(off)</sub>	-	80	100	
Slew Rate On	$R_L = 4.7 \Omega$ , $V_{in} = 0$ to 10 V, $V_{DD} = 12 V$	-dV <sub>DS</sub> /dt <sub>on</sub>	-	1.4	-	V/μs
Slew Rate Off $R_L = 4.7 \Omega$ , $V_{in} = 10 \text{ to } 0 \text{ V}$ , $V_{DD} = 12 \text{ V}$		dV <sub>DS</sub> /dt <sub>off</sub>	-	0.5	-	V/μs
SELF PROTECTION CHARAC	TERISTICS (T <sub>J</sub> = 25°C unless otherwise n	oted) (Note 5)				
Current Limit	$V_{DS} = 10 \text{ V } (V_{GS} = 5.0 \text{ Vdc})$ $V_{DS} = 10 \text{ V } (V_{GS} = 5.0 \text{ Vdc}, T_J = 150^{\circ}\text{C})$	I <sub>LIM</sub>	12 7	18 13	24 18	Adc
Current Limit $(V_{GS} = 10 \text{ Vdc})$ $V_{DS} = 10 \text{ V } (V_{GS} = 10 \text{ Vdc}, T_J = 150^{\circ}\text{C})$		I <sub>LIM</sub>	18 13	22 18	30 25	
Temperature Limit (Turn-off) V <sub>GS</sub> = 5.0 Vdc		T <sub>LIM(off)</sub>	150	175	200	°C
Thermal Hysteresis V <sub>GS</sub> = 5.0 Vdc		$\Delta T_{LIM(on)}$	-	15	-	°C
Temperature Limit (Turn-off) V <sub>GS</sub> = 10 Vdc		T <sub>LIM(off)</sub>	150	165	185	°C
Thermal Hysteresis V <sub>GS</sub> = 10 Vdc		$\Delta T_{LIM(on)}$	-	15	-	°C
Input Current during $V_{DS} = 35 \text{ V}, (V_{GS} = 5.0 \text{ V}, T_j = 150^{\circ}\text{C})$ Thermal Fault		I <sub>g(fault)</sub>	0.6	-	-	mA
Input Current during $V_{DS} = 35 \text{ V}, (V_{GS} = 10 \text{ V}, T_j = 150^{\circ}\text{C})$ Thermal Fault		I <sub>g(fault)</sub>	2.0	-	-	mA
ESD ELECTRICAL CHARACT	<b>ERISTICS</b> ( $T_J = 25^{\circ}C$ unless otherwise not	ed)			· -	
Electro-Static Discharge Capa Human Body Model Machine Model (MM	ESD	4000 400	- -		V	

<sup>4.</sup> Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
5. Fault conditions are viewed as beyond the normal operating range of the part.

#### TYPICAL PERFORMANCE CURVES

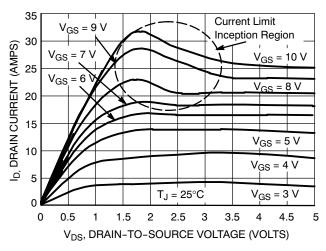


Figure 1. On-Region Characteristics

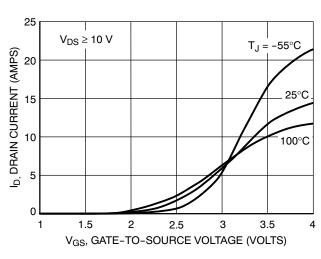


Figure 2. Transfer Characteristics

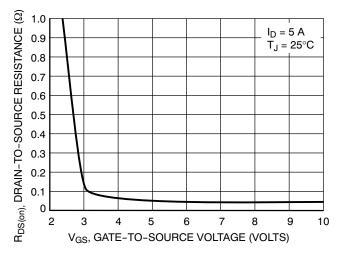


Figure 3. On-Resistance vs. Gate-to-Source Voltage

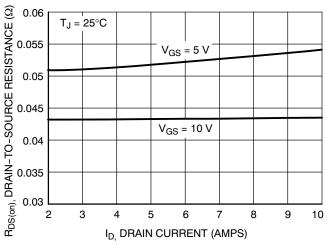


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

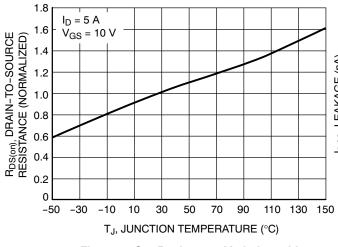


Figure 5. On-Resistance Variation with Temperature

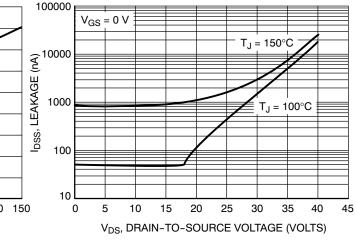


Figure 6. Drain-to-Source Leakage Current vs. Voltage

# **TYPICAL PERFORMANCE CURVES**

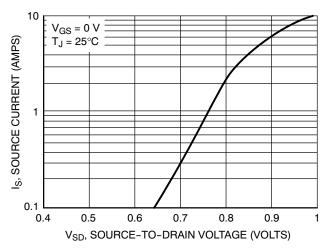
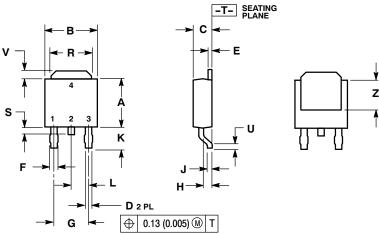


Figure 7. Diode Forward Voltage vs. Current

#### PACKAGE DIMENSIONS

#### **DPAK** CASE 369C-01 **ISSUE O**



# **SOLDERING FOOTPRINT**



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.235	0.245	5.97	6.22
В	0.250	0.265	6.35	6.73
С	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.018	0.023	0.46	0.58
F	0.037	0.045	0.94	1.14
G	0.180 BSC		4.58 BSC	
Н	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29	BSC
R	0.180	0.215	4.57	5.45
S	0.025	0.040	0.63	1.01
U	0.020		0.51	
V	0.035	0.050	0.89	1.27
Z	0.155		3.93	

STYLE 2:

- PIN 1. GATE 2. DRAIN
  - 3. SOURCE 4. DRAIN

	$-\frac{6.20}{0.244} \longrightarrow$	→ 3.0 0.118
	2.58 0.101 →	<u> </u>
5.80 0.228		$ \begin{array}{c c}  & 1.6 \\ \hline  & 0.063 \\ \hline \end{array} $ $ \begin{array}{c c}  & 6.172 \\ \hline  & 0.243 \\ \hline \end{array} $
		SCALE 3:1 (mn

HDPlus is a trademark of Semiconductor Components Industries, LLC (SCILLC)

ON Semiconductor and un are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative